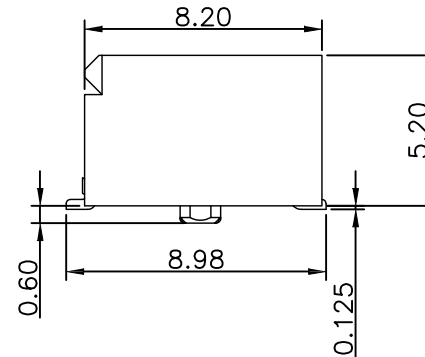
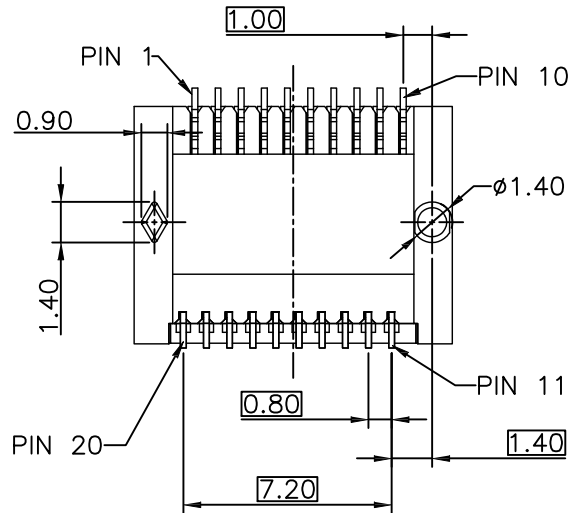
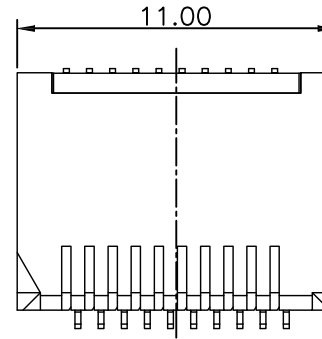
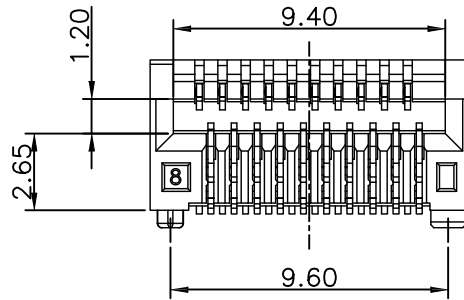


RoHS compliant



NOTES:

1.MATERIAL

HOUSING: HIGH TEMPERATURE LCP, UL94 V-0.

2.CONTACTS: PHOSPHOR BRONZE

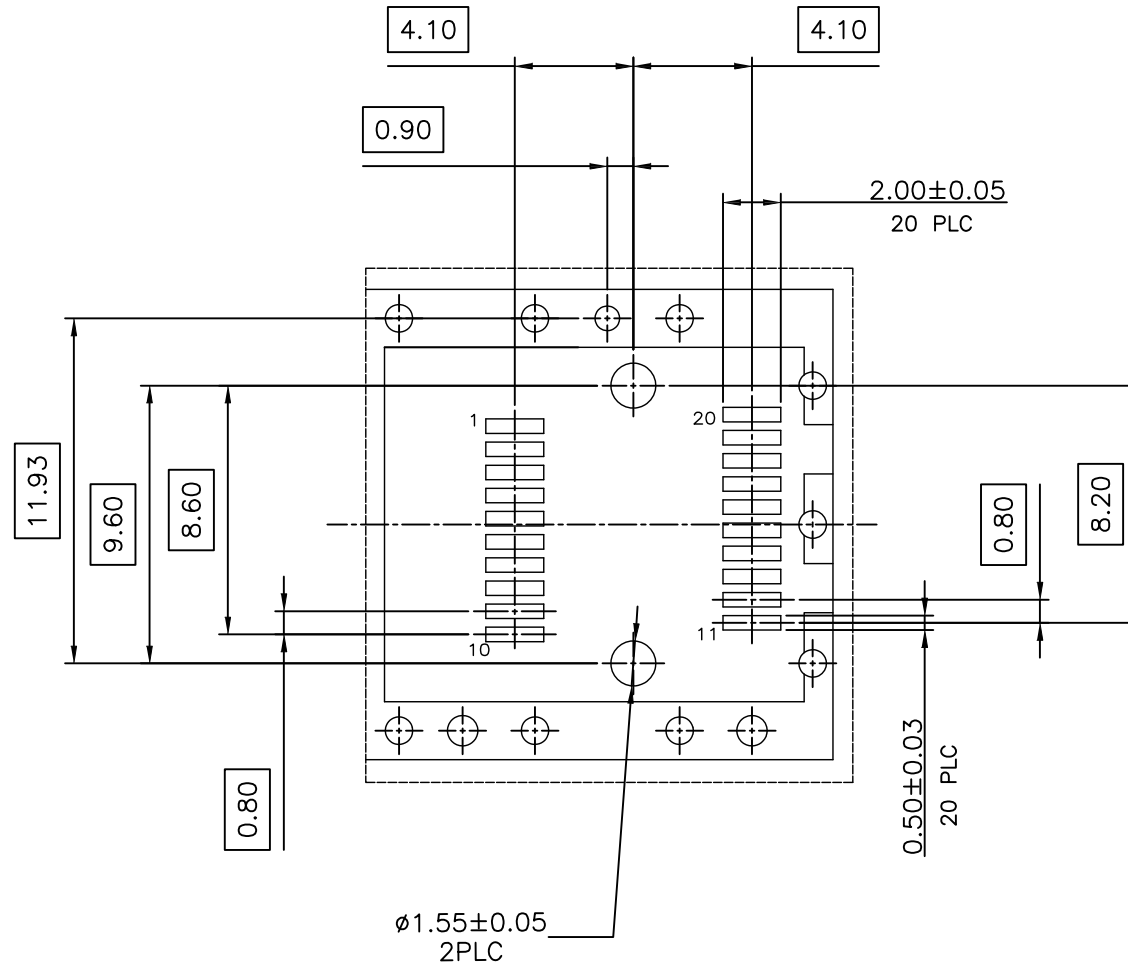
PLATING :15μ" GOLD ON MATING AREA,
100μ" MATTE TIN PLATING ON
SOLDER TAILS, 50μ" NICKEL
UNDERPLATING OVERALL.

3.PACKAGING: TAPE AND REEL

4.TEMPERATURE RANGE: -55°C TO +85°C

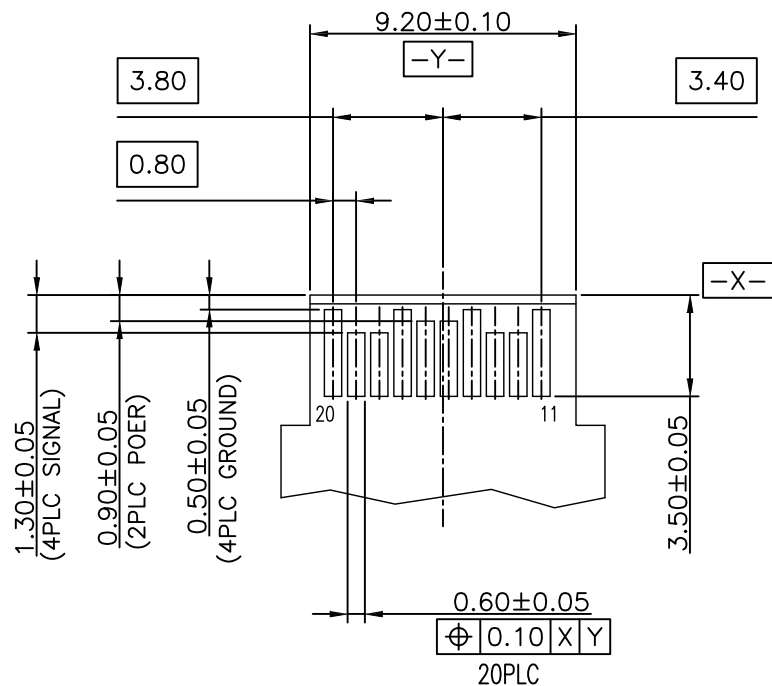
					GENERAL TOLERANCE		DRAWN	Gene Li	2017/03/21	UNIT	MM	X-SHUN 东莞市祥舜电子科技有限公司 DONGGUAN X-SHUN ELECTRONIC TECHNOLOGY CO., LTD TEL:+86 769 81885389 FAX:+86 769 81887859 E-Mail:sales@x-shun.com Http:www.x-shun.com				
					.X	±0.35	X.°	± 2°	CHECKE	HYY		SCALE	1:1			
					.XX	±0.25	X.°	± 1°								
A0		NEW DESIGN	2017/03/21		.XXX	±0.15	.XX°	± 0.5°	APPROVE			SHEET	1/3	PART NO.	9001-2C2100A-00B	
REV	ECN NO	DESCRIPTION	DATE	SIGNATURE	PROJECT			DRAWING NO				REV	A0	TITLE	SFP 1X1 CONNECTOR	
1		2		3		4		5		6		7		8		

RoHS compliant

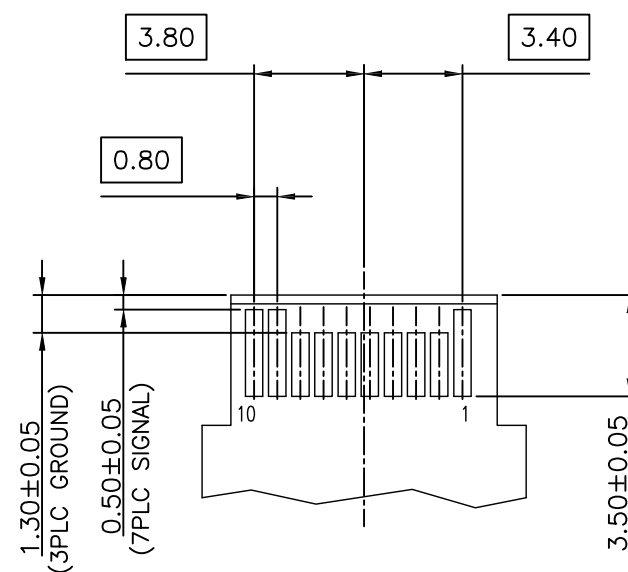


					GENERAL TOLERANCE		DRAWN	Gene Li	2017/03/21	UNIT	MM	X-SHUN 东莞市祥舜电子科技有限公司 DONGGUAN X-SHUN ELECTRONICTECHNOLOGY CO., LTD TEL:+86 769 81885389 FAX:+86 769 81887859 E-Mail:sales@x-shun.com Http:www.x-shun.com				
					.X	±0.35	X.°	± 2°	CHECKE	HYY				SCALE	1:1	
					.XX	±0.25	.X.°	± 1°								
A0		NEW DESIGN	2017/03/21		.XXX	±0.15	.XX°	± 0.5°	APPROVE			SHEET	2/3	PART NO.	9001-2C2100A-00B	
REV	ECN NO	DESCRIPTION	DATE	SIGNATURE	PROJECT			DRAWING NO				REV	A0	TITLE	SFP 1X1 CONNECTOR	

RoHS compliant



TOP VIEW OF BOARD



BOTTOM VIEW OF BOARD

RECOMMENDED LAYOUT DETAIL MATING TRANSCEIVER PCB

					GENERAL TOLERANCE		DRAWN	Gene Li	2017/03/21	UNIT	MM	X-SHUN 东莞市祥舜电子科技有限公司 DONGGUAN X-SHUN ELECTRONICTECHNOLOGY CO., LTD TEL:+86 769 81885389 FAX:+86 769 81887859 E-Mail:sales@x-shun.com Http:www.x-shun.com		
					.X ±0.35	X.° ± 2°	CHECKE	HYY		SCALE	1:1			
					.XX ±0.25	.X° ± 1°								
A0		NEW DESIGN	2017/03/21		.XXX ±0.15	.XX° ± 0.5°	APPROVE			SHEET	3/3			PART NO.
REV	ECN NO	DESCRIPTION	DATE	SIGNATURE	PROJECT 		DRAWING NO				REV	A0	TITLE	SFP 1X1 CONNECTOR